# SIR882DP-VB Datasheet

## N-Channel 100-V (D-S) MOSFET

| PRODUCT SUMMARY | | |
|---|---|---|
| $V_{(BR)DSS}$ (V) | $r_{DS(on)}$ (Ω) | $I_D$ (A) |
| 100 | 0.006 at $V_{GS}$ = 10 V | 95 |

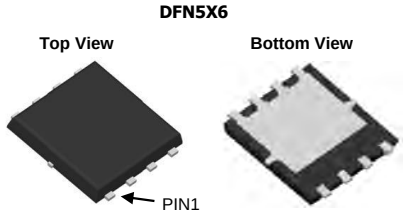
### FEATURES

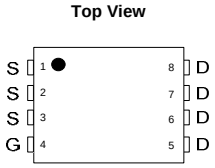
- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % $R_g$ Tested

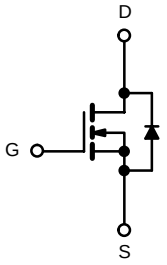
RoHS COMPLIANT

### APPLICATIONS

- Isolated DC/DC Converters




N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ($T_A$ = 25 °C, unless otherwise noted) | | | | |
|---|---|---|---|---|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Drain-source voltage | | $V_{DS}$ | 100 | V |
| Gate-source voltage | | $V_{GS}$ | ± 20 | |
| Continuous drain current ($T_J$ = 150 °C) | $T_C$ = 25 °C | $I_D$ | 95 | A |
| | $T_C$ = 70 °C | | 85 | |
| | $T_A$ = 25 °C | | 30 [b, c] | |
| | $T_A$ = 70 °C | | 25.5 [b, c] | |
| Pulsed drain current (t = 100 µs) | | $I_{DM}$ | 250 | |
| Continuous source-drain diode current | $T_C$ = 25 °C | $I_S$ | 70 | |
| | $T_A$ = 25 °C | | 6.8 [b, c] | |
| Single pulse avalanche current | L = 0.1 mH | $I_{AS}$ | 38 | |
| Single pulse avalanche energy | | $E_{AS}$ | 50 | mJ |
| Maximum power dissipation | $T_C$ = 25 °C | $P_D$ | 100 | W |
| | $T_C$ = 70 °C | | 70 | |
| | $T_A$ = 25 °C | | 6 [b, c] | |
| | $T_A$ = 70 °C | | 4.2 [b, c] | |
| Operating junction and storage temperature range | | $T_J$, $T_{stg}$ | -55 to +150 | °C |
| Soldering recommendations (peak temperature) [c] | | | 260 | |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|---|---|---|---|---|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT |
| Maximum junction-to-ambient [b] | t ≤ 10 s | $R_{thJA}$ | 20 | 25 | °C/W |
| Maximum junction-to-case (drain) | Steady state | $R_{thJC}$ | 1.6 | 2 | |

**Notes**
a. Package limited
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s

| **SPECIFICATIONS** ($T_J$ = 25 °C, unless otherwise noted) | | | | | | |
|---|---|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TEST CONDITIONS** | **MIN.** | **TYP.** | **MAX.** | **UNIT** |
| **Static** | | | | | | |
| Drain-source breakdown voltage | $V_{DS}$ | $V_{GS}$ = 0 V, $I_D$ = 250 µA | 100 | - | - | V |
| $V_{DS}$ temperature coefficient | $\Delta V_{DS}/T_J$ | $I_D$ = 10 mA | - | 81 | - | mV/°C |
| $V_{GS(th)}$ temperature coefficient | $\Delta V_{GS(th)}/T_J$ | $I_D$ = 250 µA | - | -7.5 | - | |
| Gate-source threshold voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 µA | 2 | - | 5 | V |
| Gate-source leakage | $I_{GSS}$ | $V_{DS}$ = 0 V, $V_{GS}$ = ± 20 V | - | - | 100 | nA |
| Zero gate voltage drain current | $I_{DSS}$ | $V_{DS}$ = 100 V, $V_{GS}$ = 0 V | - | - | 1 | µA |
| | | $V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_J$ = 70 °C | - | - | 15 | |
| On-state drain current [a] | $I_{D(on)}$ | $V_{DS}$ ≥ 10 V, $V_{GS}$ =10 V | 60 | - | - | A |
| Drain-source on-state resistance [a] | $R_{DS(on)}$ | $V_{GS}$ =10 V, $I_D$ = 10 A | - | 0.006 | - | Ω |
| | | $V_{GS}$ = 7.5 V, $I_D$ = 10 A | - | 0.008 | - | |
| Forward transconductance [a] | $g_{fs}$ | $V_{DS}$ = 15 V, $I_D$ = 10 A | - | 46 | - | S |
| **Dynamic [b]** | | | | | | |
| Input capacitance | $C_{iss}$ | $V_{DS}$ = 50 V, $V_{GS}$ = 0 V, f = 1 MHz | - | 6500 | - | pF |
| Output capacitance | $C_{oss}$ | | - | 132 | - | |
| Reverse transfer capacitance | $C_{rss}$ | | - | 11.2 | - | |
| Total gate charge | $Q_g$ | $V_{DS}$ = 50 V, $V_{GS}$ = 10 V, $I_D$ = 10 A | - | 20 | - | nC |
| | | $V_{DS}$ = 50 V, $V_{GS}$ = 7.5 V, $I_D$ = 10 A | - | 15 | - | |
| Gate-source charge | $Q_{gs}$ | | - | 6.45 | - | |
| Gate-drain charge | $Q_{gd}$ | | - | 3.5 | - | |
| Output charge | $Q_{oss}$ | $V_{DS}$ = 50 V, $V_{GS}$ = 0 V | - | 22 | - | |
| Gate resistance | $R_g$ | f = 1 MHz | 0.2 | 0.76 | 1.4 | Ω |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD}$ = 50 V, $R_L$ = 5 Ω, $I_D$ ≅ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 Ω | - | 12 | 24 | ns |
| Rise time | $t_r$ | | - | 5 | 10 | |
| Turn-off delay time | $t_{d(off)}$ | | - | 19 | 38 | |
| Fall time | $t_f$ | | - | 5 | 10 | |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD}$ = 50 V, $R_L$ = 5 Ω, $I_D$ ≅ 10 A, $V_{GEN}$ = 7.5 V, $R_g$ = 1 Ω | - | 15 | 30 | |
| Rise time | $t_r$ | | - | 6 | 12 | |
| Turn-off delay time | $t_{d(off)}$ | | - | 19 | 38 | |
| Fall time | $t_f$ | | - | 5 | 10 | |
| **Drain-Source Body Diode Characteristics** | | | | | | |
| Continuous source-drain diode current | $I_S$ | $T_C$ = 25 °C | - | - | 70 | A |
| Pulse diode forward current | $I_{SM}$ | | - | - | 80 | |
| Body diode voltage | $V_{SD}$ | $I_S$ = 5 A, $V_{GS}$ = 0 V | - | 0.78 | 1.1 | V |
| Body diode reverse recovery time | $t_{rr}$ | $I_F$ = 10 A, di/dt = 100 A/µs, $T_J$ = 25 °C | - | 43 | 86 | ns |
| Body diode reverse recovery charge | $Q_{rr}$ | | - | 72 | 144 | nC |
| Reverse recovery fall time | $t_a$ | | - | 33 | - | ns |
| Reverse recovery rise time | $t_b$ | | - | 10 | - | |

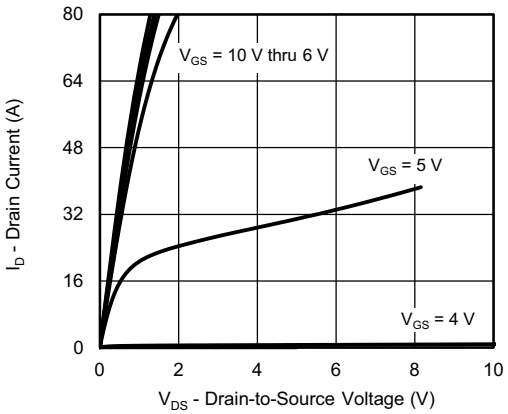
**Notes**

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %

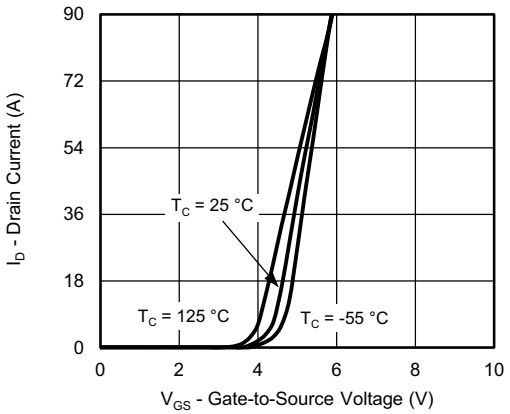
b. Guaranteed by design, not subject to production testing

*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

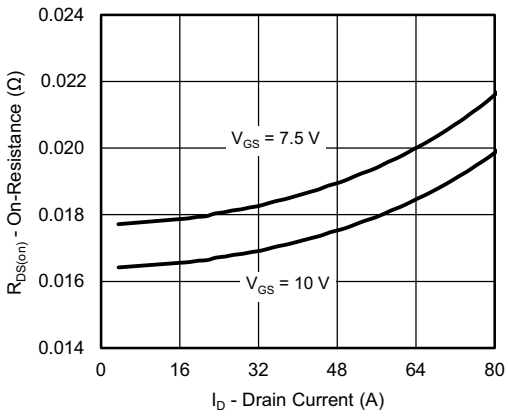
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



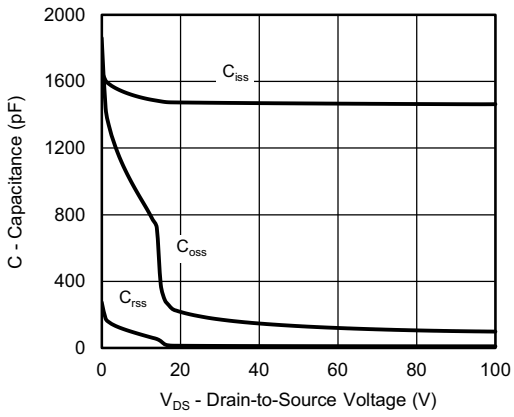

**Output Characteristics**



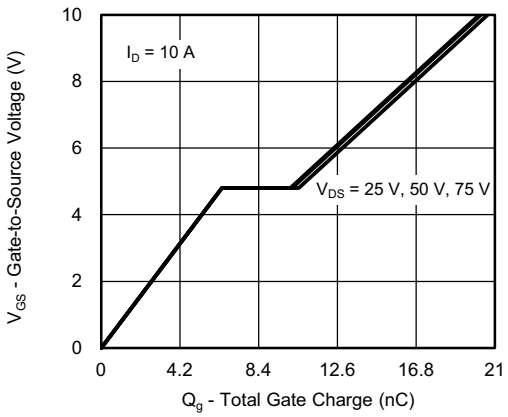

**Transfer Characteristics**



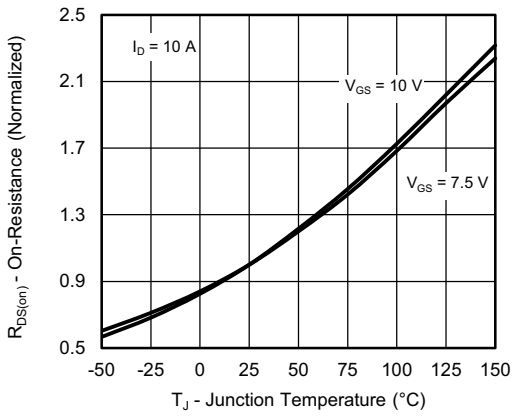

**On-Resistance vs. Drain Current and Gate Voltage**




**Capacitance**

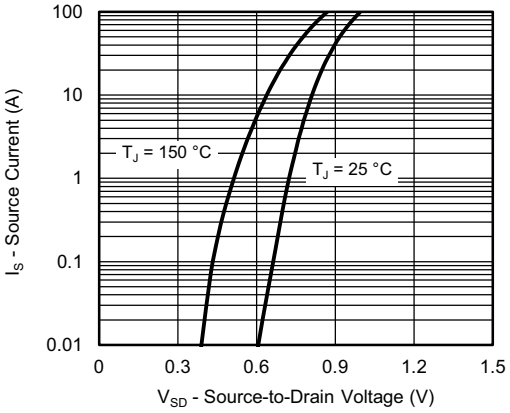



**Gate Charge**

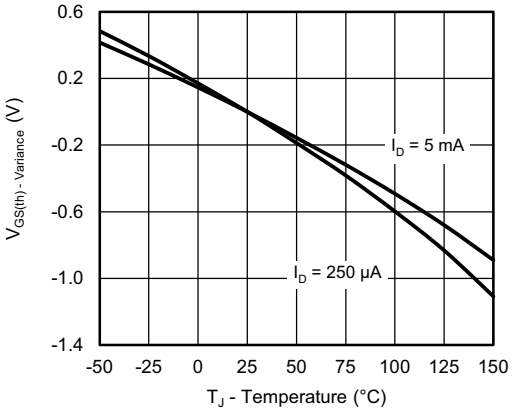



**On-Resistance vs. Junction Temperature**

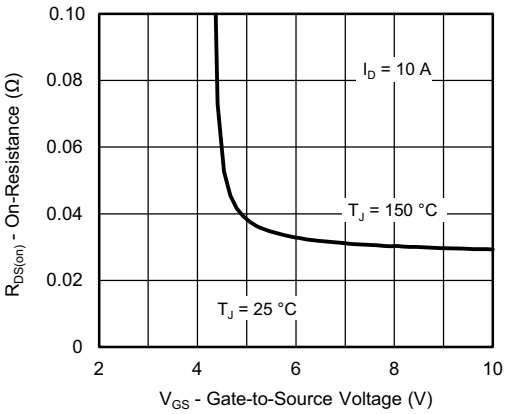
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



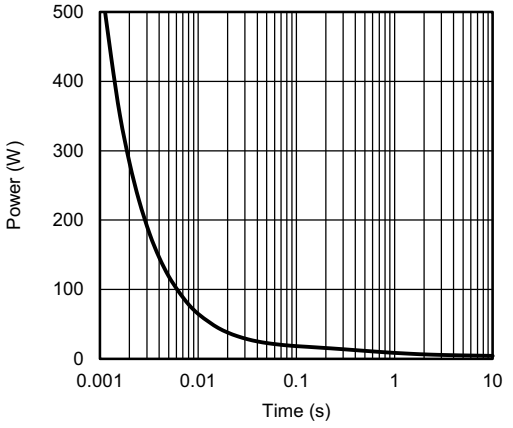

**Source-Drain Diode Forward Voltage**



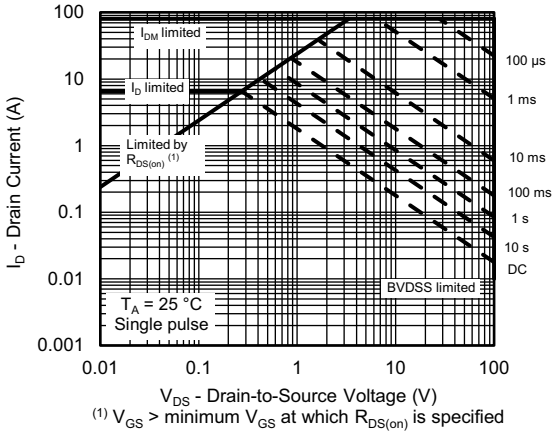

**Threshold Voltage**




**On-Resistance vs. Gate-to-Source Voltage**

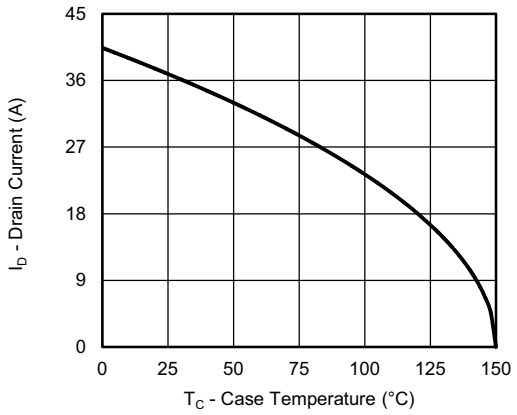



**Single Pulse Power, Junction-to-Ambient**

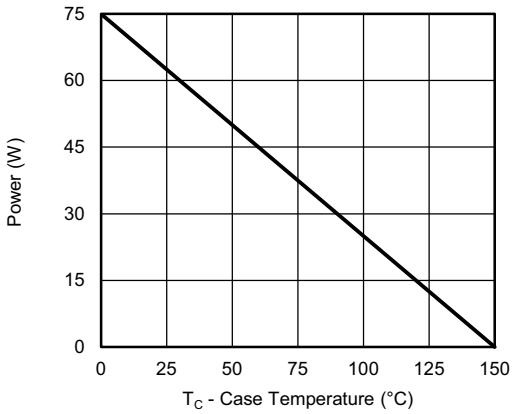



**Safe Operating Area, Junction-to-Ambient**

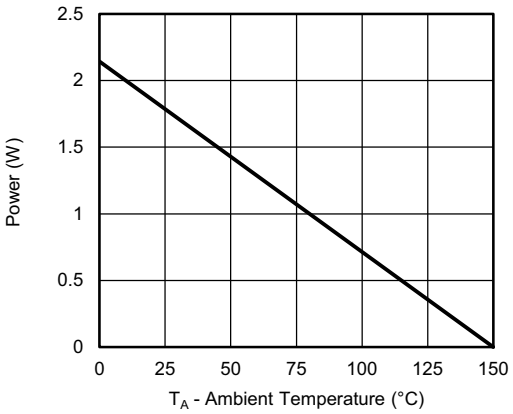
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)




**Current Derating** [a]




**Power, Junction-to-Case**

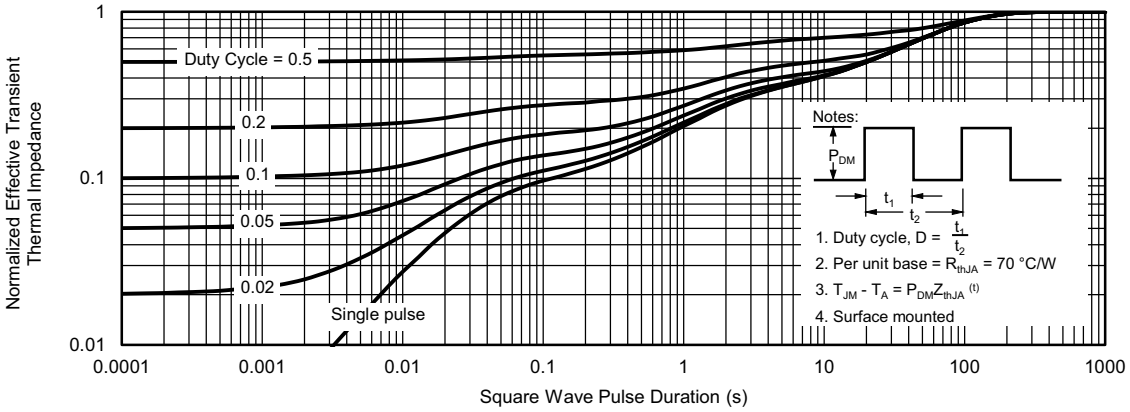



**Power, Junction-to-Ambient**

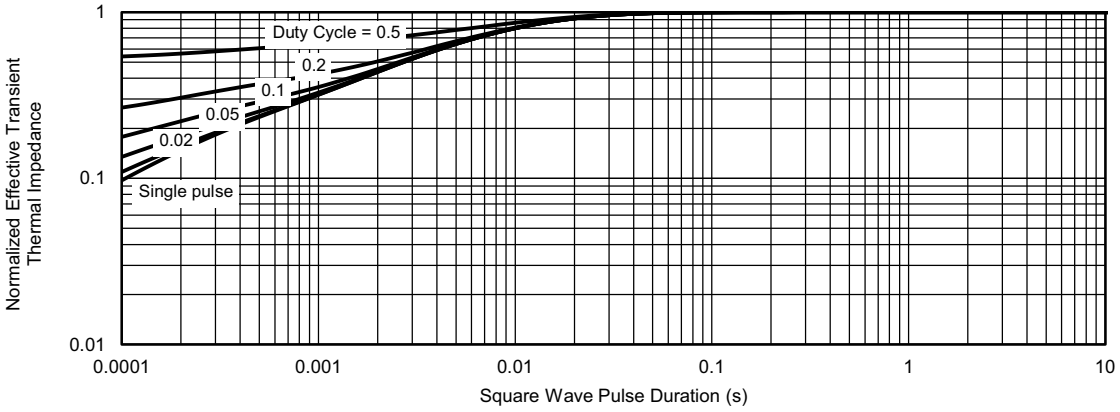
**Note**

a. The power dissipation $P_D$ is based on $T_J$ max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

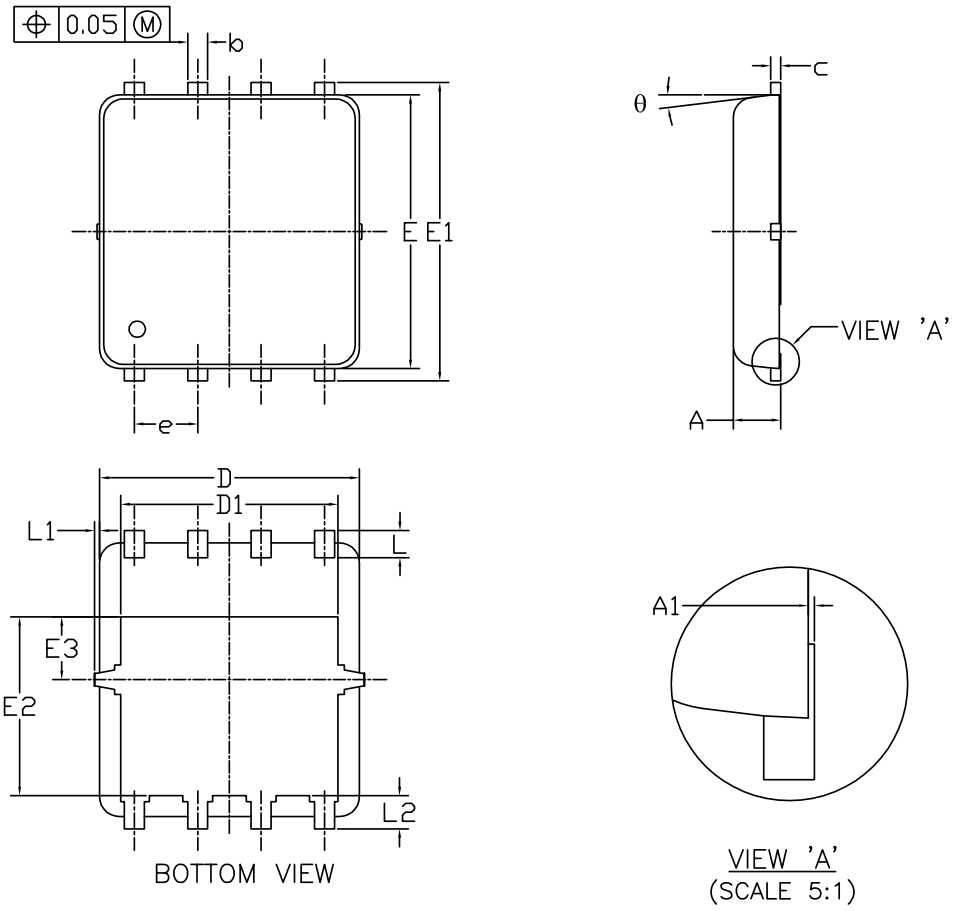



**Normalized Thermal Transient Impedance, Junction-to-Ambient**

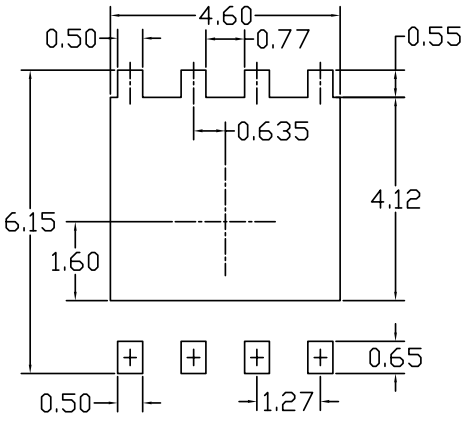



**Normalized Thermal Transient Impedance, Junction-to-Case**

## DFN5x6_8L_EP1_P PACKAGE OUTLIN




RECOMMENDED LAND PATTERN




| SYMBOLS | DIMENSIONS IN MILLIMETERS | | | DIMENSIONS IN INCHES | | |
|---|---|---|---|---|---|---|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.85 | 0.95 | 1.00 | 0.033 | 0.037 | 0.039 |
| A1 | 0.00 | --- | 0.05 | 0.000 | --- | 0.002 |
| b | 0.30 | 0.40 | 0.50 | 0.012 | 0.016 | 0.020 |
| c | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D | 5.10 | 5.20 | 5.30 | 0.201 | 0.205 | 0.209 |
| D1 | 4.25 | 4.35 | 4.45 | 0.167 | 0.171 | 0.175 |
| E | 5.45 | 5.55 | 5.65 | 0.215 | 0.219 | 0.222 |
| E1 | 5.95 | 6.05 | 6.15 | 0.234 | 0.238 | 0.242 |
| E2 | 3.525 | 3.625 | 3.725 | 0.139 | 0.143 | 0.147 |
| E3 | 1.175 | 1.275 | 1.375 | 0.046 | 0.050 | 0.054 |
| e | 1.27 BSC | | | 0.050 BSC | | |
| L | 0.45 | 0.55 | 0.65 | 0.018 | 0.022 | 0.026 |
| L1 | 0 | --- | 0.15 | 0 | --- | 0.006 |
| L2 | 0.68 REF | | | 0.027 REF | | |
| θ | 0° | --- | 10° | 0° | --- | 10° |

UNIT: mm

NOTE

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
   MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
2. CONTROLLING DIMENSION IS MILLIMETER.
   CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

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Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

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**Kategorilere göz atın**

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Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

**Üreticileri görün**

### Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

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